

74ALVC573

Octal D-type transparent latch; 3-state

Rev. 4 — 30 April 2021

Product data sheet

1. General description

The 74ALVC573 is an octal D-type transparent latch featuring separate D-type inputs for each latch and 3-state true outputs for bus-oriented applications. A latch enable (LE) input and an outputs enable (\overline{OE}) input are common to all latches.

When pin LE is HIGH, data at the D-inputs (pins D0 to D7) enters the latches. In this condition, the latches are transparent, that is, a latch output will change each time its corresponding D-input changes. When pin LE is LOW, the latches store the information that was present at the D-inputs one set-up time preceding the HIGH-to-LOW transition of pin LE.

When pin \overline{OE} is LOW, the contents of the eight latches are available at the Q-outputs (pins Q0 to Q7). When pin \overline{OE} is HIGH, the outputs go to the high-impedance OFF-state. Operation of input pin \overline{OE} does not affect the state of the latches.

The 74ALVC573 is functionally identical to the 74ALVC373, but has a different pin arrangement.

2. Features and benefits

- Wide supply voltage range from 1.65 V to 3.6 V
- 3.6 V tolerant inputs/outputs
- CMOS low power consumption
- Direct interface with TTL levels (2.7 V to 3.6 V)
- Power-down mode
- Latch-up performance exceeds 250 mA
- Complies with JEDEC standards:
 - JESD8-7 (1.65 V to 1.95 V)
 - JESD8-5 (2.3 V to 2.7 V)
 - JESD8B (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114E exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V

3. Ordering information

Table 1. Ordering information

Type number	Package			Version
	Temperature range	Name	Description	
74ALVC573D	-40 °C to +85 °C	SO20	plastic small outline package; 20 leads; body width 7.5 mm	SOT163-1
74ALVC573PW	-40 °C to +85 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-1
74ALVC573BQ	-40 °C to +85 °C	DHVQFN20	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 × 4.5 × 0.85 mm	SOT764-1

4. Functional diagram

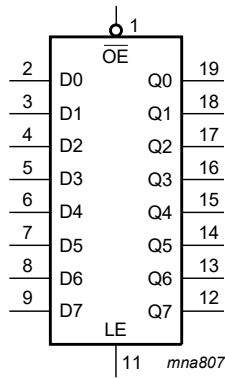


Fig. 1. Logic symbol

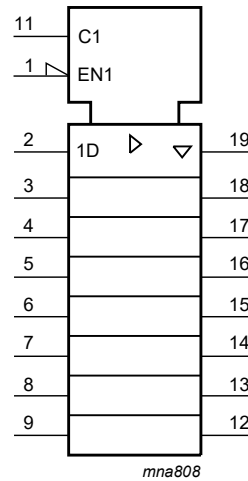


Fig. 2. IEC logic symbol

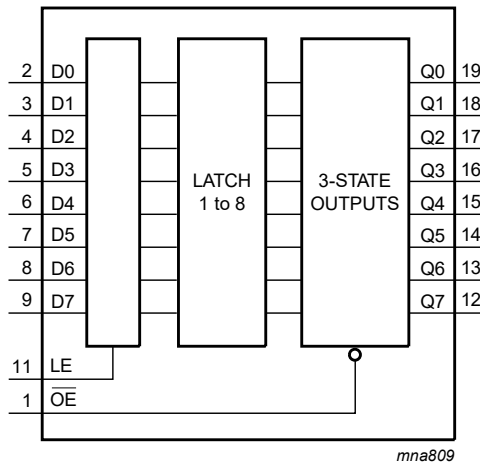


Fig. 3. Functional diagram

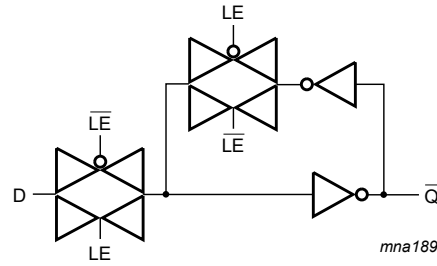


Fig. 4. Logic diagram (one latch)

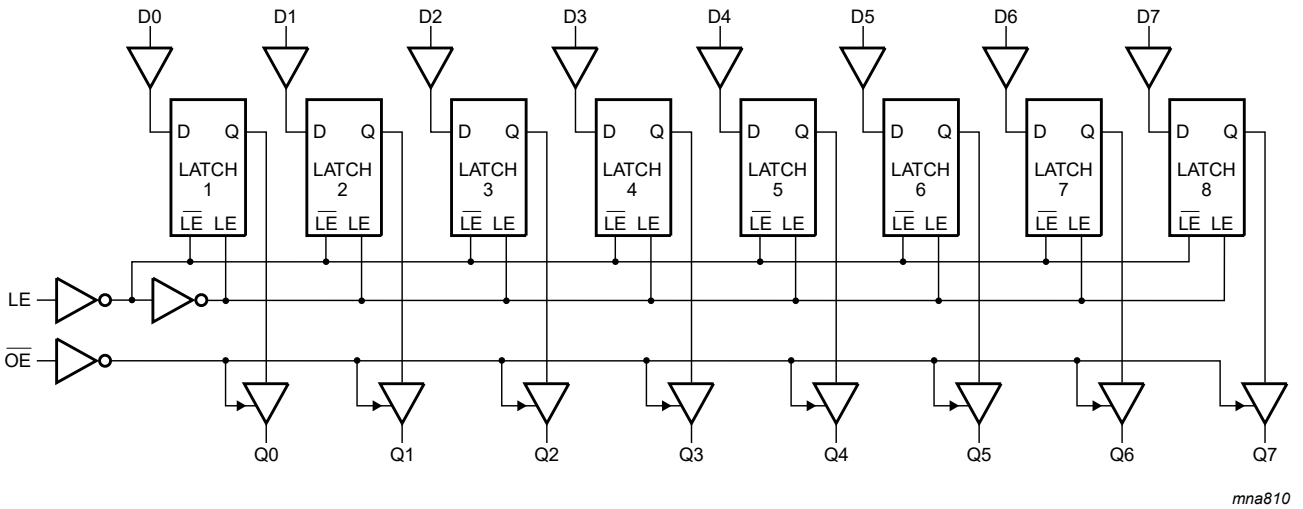


Fig. 5. Logic diagram

5. Pinning information

5.1. Pinning

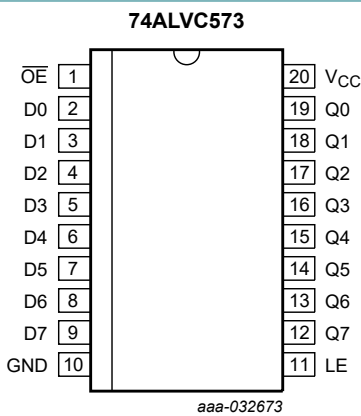


Fig. 6. Pin configuration SOT163-1 (SO20)

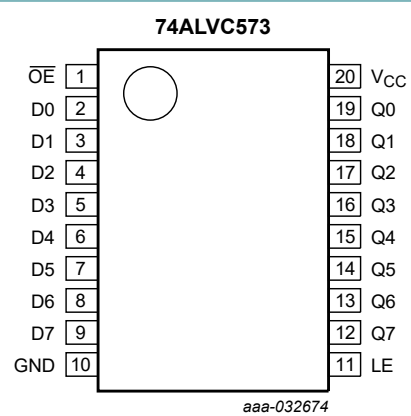
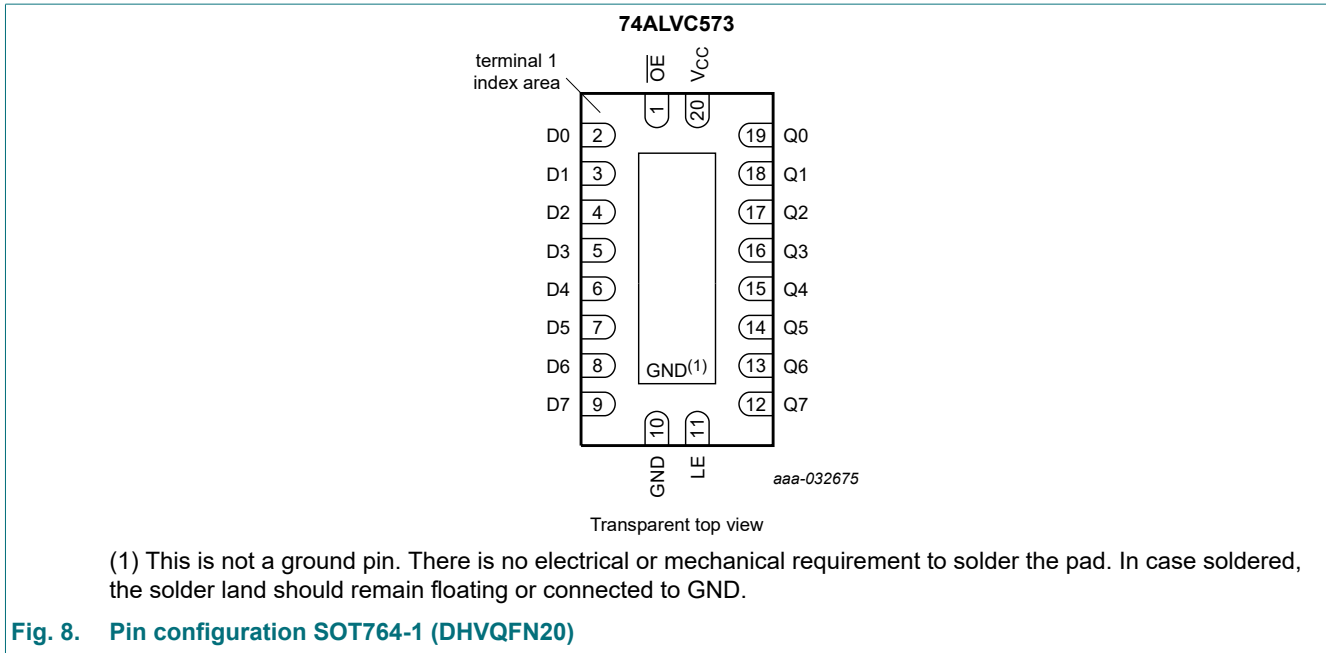


Fig. 7. Pin configuration SOT360-1 (TSSOP20)



5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
D0, D1, D2, D3, D4, D5, D6, D7	2, 3, 4, 5, 6, 7, 8, 9	data input
LE	11	latch enable input (active HIGH)
\overline{OE}	1	output enable input (active LOW)
Q0, Q1, Q2, Q3, Q4, Q5, Q6, Q7	19, 18, 17, 16, 15, 14, 13, 12	3-state latch output
V _{CC}	20	supply voltage
GND	10	ground (0 V)

6. Functional description

Table 3. Functional table

H = HIGH voltage level; h = HIGH voltage level one set-up time prior to the HIGH-to-LOW LE transition;
 L = LOW voltage level; l = LOW voltage level one set-up time prior to the HIGH-to-LOW LE transition;
 Z = High-impedance OFF-state.

Operating modes	Input			Internal latch	Output Qn
	\overline{OE}	LE	Dn		
Enable and read register (transparent mode)	L	H	L	L	L
	L	H	H	H	H
Latch and read register	L	L	l	L	L
	L	L	h	H	H
Latch register and disable outputs	H	L	l	L	Z
	H	L	h	H	Z

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+4.6	V
I_{IK}	input clamping current	$V_I < 0$ V	-50	-	mA
V_I	input voltage		[1] -0.5	+4.6	V
I_{OK}	output clamping current	$V_O > V_{CC}$ or $V_O < 0$ V	-	± 50	mA
V_O	output voltage	output HIGH or LOW state	[1] -0.5	$V_{CC} + 0.5$	V
		output 3-state	-0.5	+4.6	V
		power-down mode; $V_{CC} = 0$ V	-0.5	+4.6	V
I_O	output current	$V_O = 0$ V to V_{CC}	-	± 50	mA
I_{CC}	supply current		-	100	mA
I_{GND}	ground current		-100	-	mA
T_{stg}	storage temperature		-65	+150	°C
P_{tot}	total power dissipation	$T_{amb} = -40$ °C to +85 °C	-	500	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		1.65	3.6	V
V_I	input voltage		0	3.6	V
V_O	output voltage	output HIGH or LOW state	0	V_{CC}	V
		output 3-state	0	3.6	V
		power-down mode; $V_{CC} = 0$ V	0	3.6	V
T_{amb}	ambient temperature	in free air	-40	+85	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{CC} = 1.65$ V to 2.7 V	-	20	ns/V
		$V_{CC} = 2.7$ V to 3.6 V	-	10	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40 °C to +85 °C			Unit
			Min	Typ[1]	Max	
V _{IH}	HIGH-level input voltage	V _{CC} = 1.65 V to 1.95 V	0.65V _{CC}	-	-	V
		V _{CC} = 2.3 V to 2.7 V	1.7	-	-	V
		V _{CC} = 2.7 V to 3.6 V	2.0	-	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 1.65 V to 1.95 V	-	-	0.35V _{CC}	V
		V _{CC} = 2.3 V to 2.7 V	-	-	0.7	V
		V _{CC} = 2.7 V to 3.6 V	-	-	0.8	V
V _{OH}	HIGH-level output voltage	V _I = V _{IH} or V _{IL}				
		I _O = -100 µA; V _{CC} = 1.65 V to 3.6 V	V _{CC} - 0.2	-	-	V
		I _O = -6 mA; V _{CC} = 1.65 V	1.25	-	-	V
		I _O = -12 mA; V _{CC} = 2.3 V	1.8	-	-	V
		I _O = -18 mA; V _{CC} = 2.3 V	1.7	-	-	V
		I _O = -12 mA; V _{CC} = 2.7 V	2.2	-	-	V
		I _O = -18 mA; V _{CC} = 3.0 V	2.4	-	-	V
V _{OL}	LOW-level output voltage	V _I = V _{IH} or V _{IL}				
		I _O = 100 µA; V _{CC} = 1.65 V to 3.6 V	-	-	0.2	V
		I _O = 6 mA; V _{CC} = 1.65 V	-	-	0.3	V
		I _O = 12 mA; V _{CC} = 2.3 V	-	-	0.4	V
		I _O = 18 mA; V _{CC} = 2.3 V	-	-	0.6	V
		I _O = 12 mA; V _{CC} = 2.7 V	-	-	0.4	V
		I _O = 18 mA; V _{CC} = 3.0 V	-	-	0.4	V
I _I	input leakage current	V _{CC} = 3.6 V; V _I = 3.6 V or GND	-	±0.1	±5	µA
		V _I = V _{IH} or V _{IL} ; V _{CC} = 1.65 V to 3.6 V; V _O = 3.6 V or GND	-	±0.1	±10	µA
I _{OFF}	power-off leakage supply	V _{CC} = 0 V; V _I or V _O = 0 V to 3.6 V	-	±0.1	±10	µA
I _{CC}	supply current	V _{CC} = 3.6 V; V _I = V _{CC} or GND; I _O = 0 A	-	0.2	10	µA
ΔI _{CC}	additional supply current	per input pin; V _{CC} = 3.0 V to 3.6 V; V _I = V _{CC} - 0.6 V; I _O = 0 A	-	5	750	µA
C _I	input capacitance		-	3.5	-	pF

[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see [Fig. 13](#).

Symbol	Parameter	Conditions	-40 °C to +85 °C			Unit
			Min	Typ[1]	Max	
t_{pd}	propagation delay	Dn to Qn; see Fig. 9 [2]				
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	1.0	2.5	5.4	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.0	2.0	3.5	ns
		$V_{CC} = 2.7 \text{ V}$	1.0	2.3	3.6	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	1.0	2.2	3.3	ns
		LE to Qn; see Fig. 10				
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	1.0	2.8	6.0	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.0	2.1	3.8	ns
		$V_{CC} = 2.7 \text{ V}$	1.0	2.4	3.7	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	1.0	2.3	3.3	ns
t_{en}	enable time	OE to Qn; see Fig. 11 [2]				
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	1.5	3.0	6.4	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.0	2.4	4.5	ns
		$V_{CC} = 2.7 \text{ V}$	1.5	3.0	4.6	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	1.0	2.3	4.0	ns
t_{dis}	disable time	$\overline{\text{OE}}$ to Qn; see Fig. 11 [2]				
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	1.5	3.4	7.0	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.0	2.2	4.4	ns
		$V_{CC} = 2.7 \text{ V}$	1.5	2.8	4.4	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	1.0	2.7	4.4	ns
t_W	pulse width	LE pulse width HIGH; see Fig. 10				
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	3.8	-	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	3.3	-	-	ns
		$V_{CC} = 2.7 \text{ V}$	3.3	-	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	3.3	-	-	ns
t_{su}	set-up time	Dn to LE; see Fig. 12				
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	0.8	-	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	0.8	-	-	ns
		$V_{CC} = 2.7 \text{ V}$	0.8	-	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	0.8	-	-	ns
t_h	hold time	Dn to LE; see Fig. 12				
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	0.8	-	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	0.8	-	-	ns
		$V_{CC} = 2.7 \text{ V}$	0.8	-	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	0.7	-	-	ns

Symbol	Parameter	Conditions	-40 °C to +85 °C			Unit
			Min	Typ[1]	Max	
C _{PD}	power dissipation capacitance	per latch; V _I = GND to V _{CC} ; V _{CC} = 3.3 V [3]				
		outputs HIGH or LOW state	-	37	-	pF
		outputs 3-state	-	7	-	pF

- [1] Typical values are measured at T_{amb} = 25 °C
- [2] t_{pd} is the same as t_{PHL} and t_{PLH}.
t_{en} is the same as t_{PZH} and t_{PZL}.
t_{dis} is the same as t_{PHZ} and t_{PLZ}.
- [3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).
 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum(C_L \times V_{CC}^2 \times f_o)$ where:
 f_i = input frequency in MHz; f_o = output frequency in MHz
 C_L = output load capacitance in pF
 V_{CC} = supply voltage in Volts
 N = number of inputs switching
 Σ(C_L × V_{CC}² × f_o) = sum of the outputs

10.1. Waveforms and test circuit

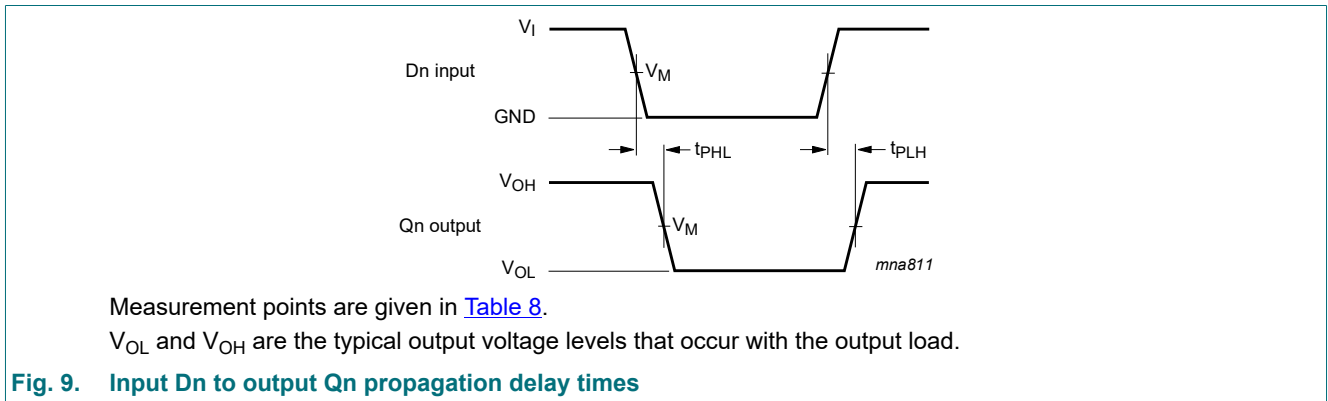
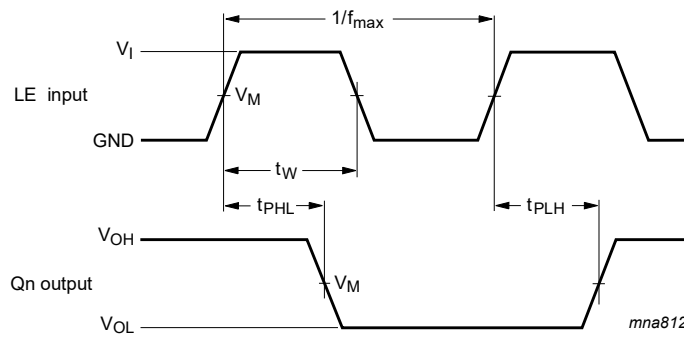


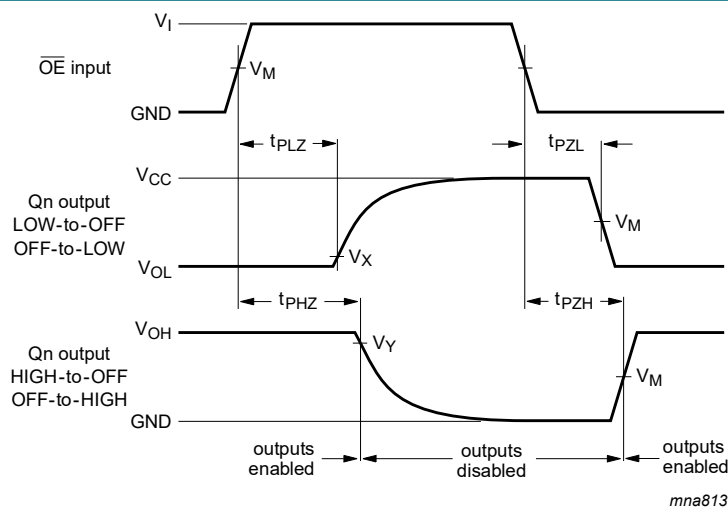
Table 8. Measurement points

Supply voltage V _{CC}	V _M	Output	
		V _X	V _Y
1.65 V to 1.95 V	0.5V _{CC}	V _{OL} + 0.15 V	V _{OH} - 0.15 V
2.3 V to 2.7 V	0.5V _{CC}	V _{OL} + 0.15 V	V _{OH} - 0.15 V
2.7 V	1.5 V	V _{OL} + 0.3 V	V _{OH} - 0.3 V
3.0 V to 3.6 V	1.5 V	V _{OL} + 0.3 V	V _{OH} - 0.3 V



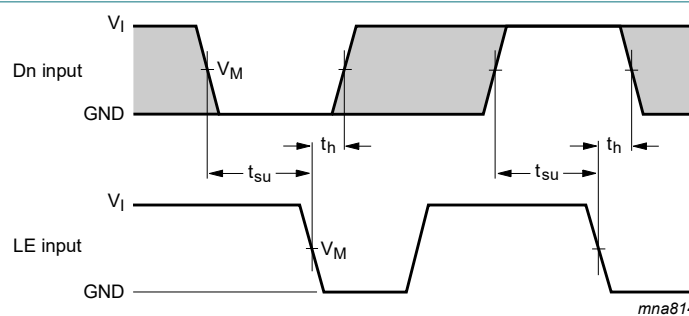
Measurement points are given in [Table 8](#).
 V_{OL} and V_{OH} are the typical output voltage levels that occur with the output load.

Fig. 10. Latch enable (LE) pulse width and latch enable input to output (Qn) propagation delays



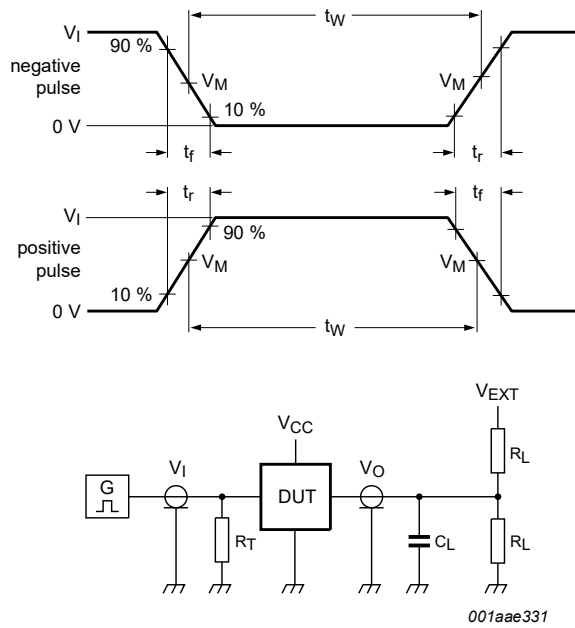
Measurement points are given in [Table 8](#).
 V_{OL} and V_{OH} are the typical output voltage levels that occur with the output load.

Fig. 11. Enable and disable times



Measurement points are given in [Table 8](#).
 The shaded areas indicate when the input is permitted to change for predictable output performance.

Fig. 12. The data set-up and hold times for Dn input to LE input



Test data is given in [Table 9](#).

Definitions for test circuit:

R_L = Load resistance.

C_L = Load capacitance including jig and probe capacitance.

R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

V_{EXT} = External voltage for measuring switching times.

Fig. 13. Test circuit for measuring switching times

Table 9. Test data

Supply voltage	Input		Load		V_{EXT}		
V_{CC}	V_I	t_r, t_f	C_L	R_L	t_{PLH}, t_{PHL}	t_{PLZ}, t_{PZL}	t_{PHZ}, t_{PZH}
1.65 V to 1.95 V	V_{CC}	≤ 2.0 ns	30 pF	1 k Ω	open	$2V_{CC}$	GND
2.3 V to 2.7 V	V_{CC}	≤ 2.0 ns	30 pF	500 Ω	open	$2V_{CC}$	GND
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	6 V	GND
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	6 V	GND

11. Package outline

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1

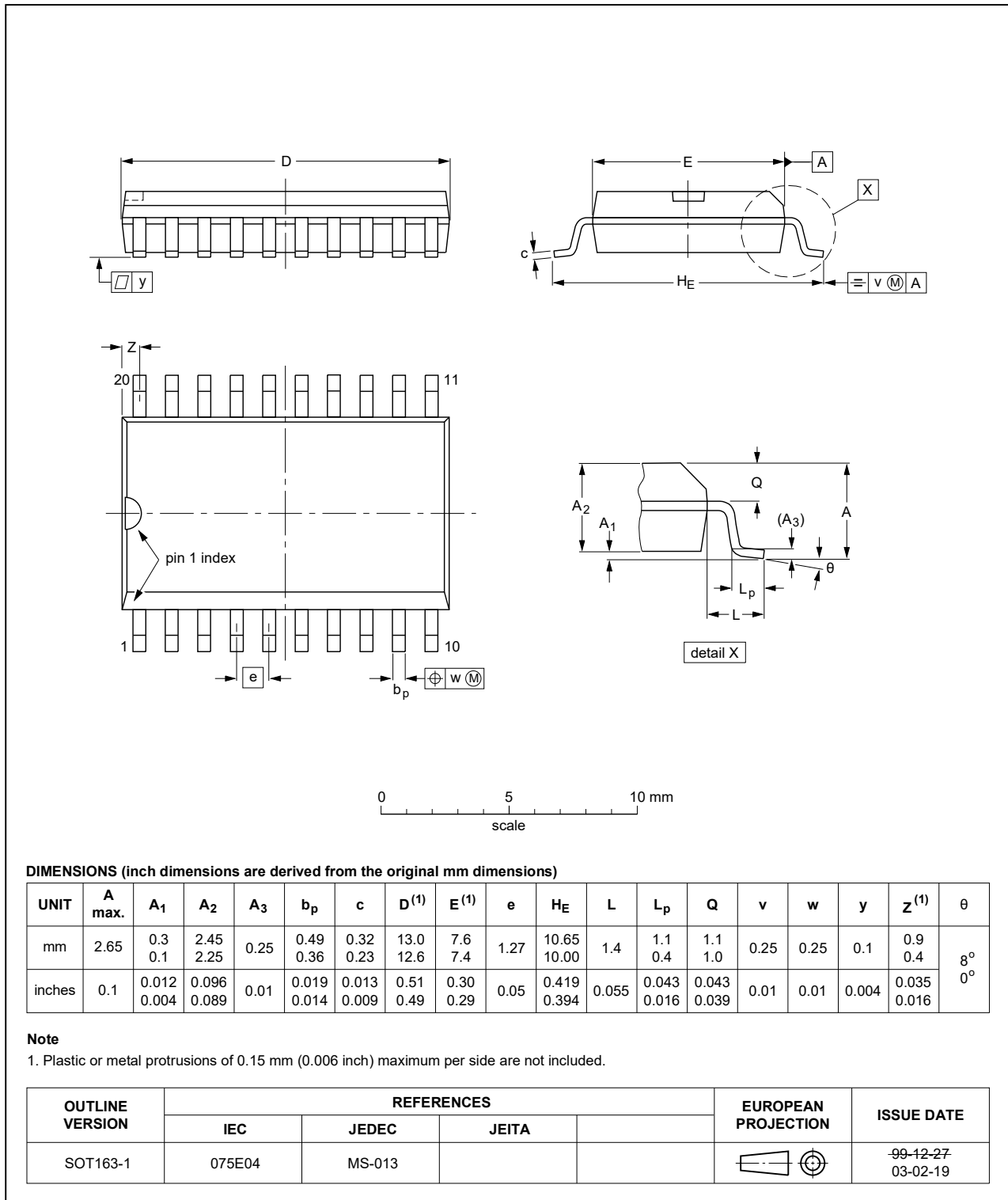


Fig. 14. Package outline SOT163-1 (SO20)

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1

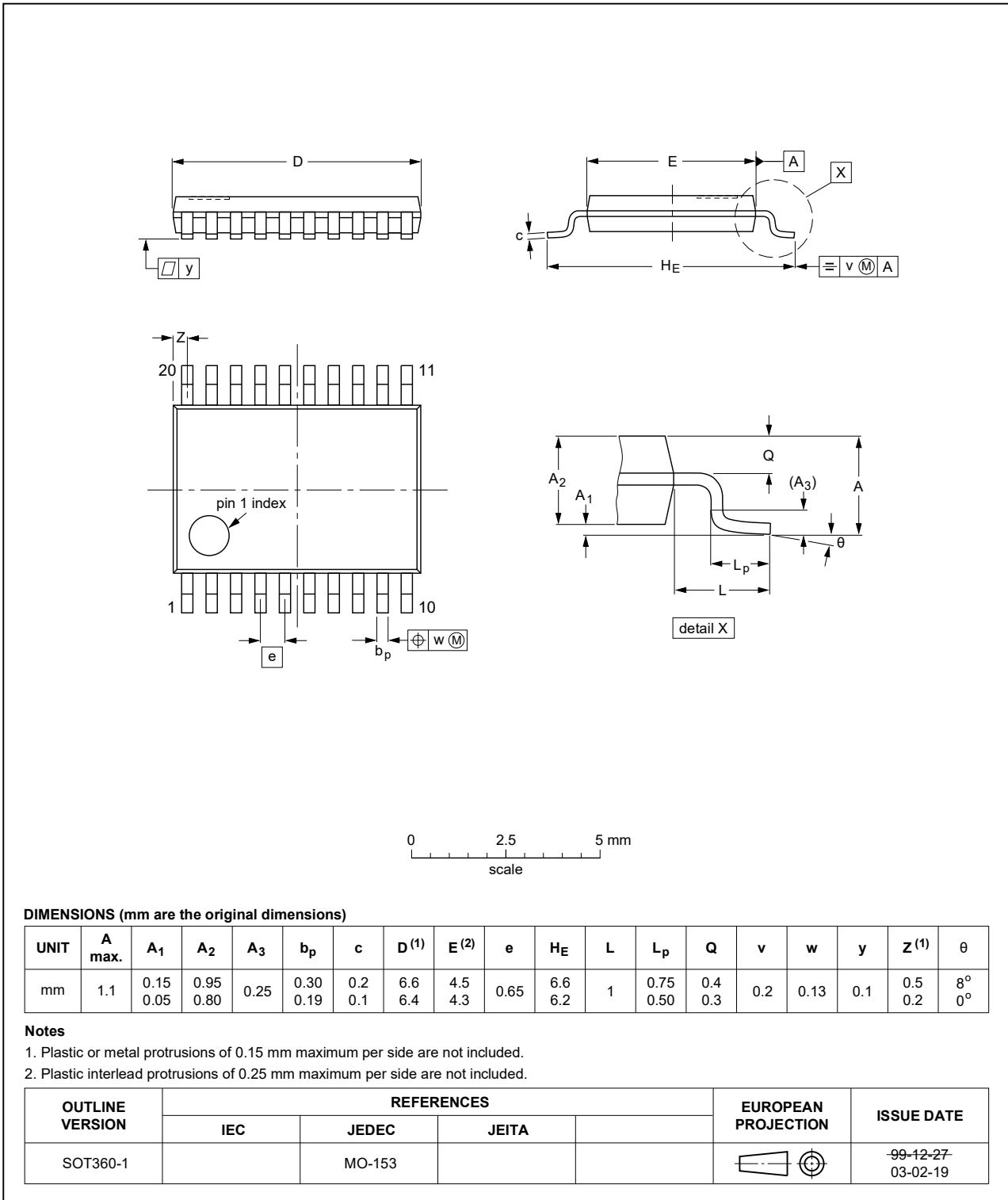


Fig. 15. Package outline SOT360-1 (TSSOP20)

DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm

SOT764-1



Fig. 16. Package outline SOT764-1 (DHVQFN20)

12. Abbreviations

Table 10. Abbreviations

Acronym	Description
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

13. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74ALVC573 v.4	20210430	Product data sheet	-	74ALVC573 v.3
Modifications:	<ul style="list-style-type: none"> The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. Legal texts have been adapted to the new company name where appropriate. Section 2: Reference to JESD36 removed. Section 7: Derating values for P_{tot} total power dissipation removed (errata). Package outline drawing of SOT764-1 (Fig. 16) updated. 			
74ALVC573 v.3	20071026	Product data sheet	-	74ALVC573 v.2
Modifications:	<ul style="list-style-type: none"> The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. Legal texts have been adapted to the new company name where appropriate. Section 3: DHVQFN20 package added. Section 7: derating values added for DHVQFN20 package. Section 11: outline drawing added for DHVQFN20 package. 			
74ALVC573 v.2	20030625	Product specification	-	74ALVC573 v.1
74ALVC573 v.1	20020301	Product specification	-	-

14. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <https://www.nexperia.com>.

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